mail

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

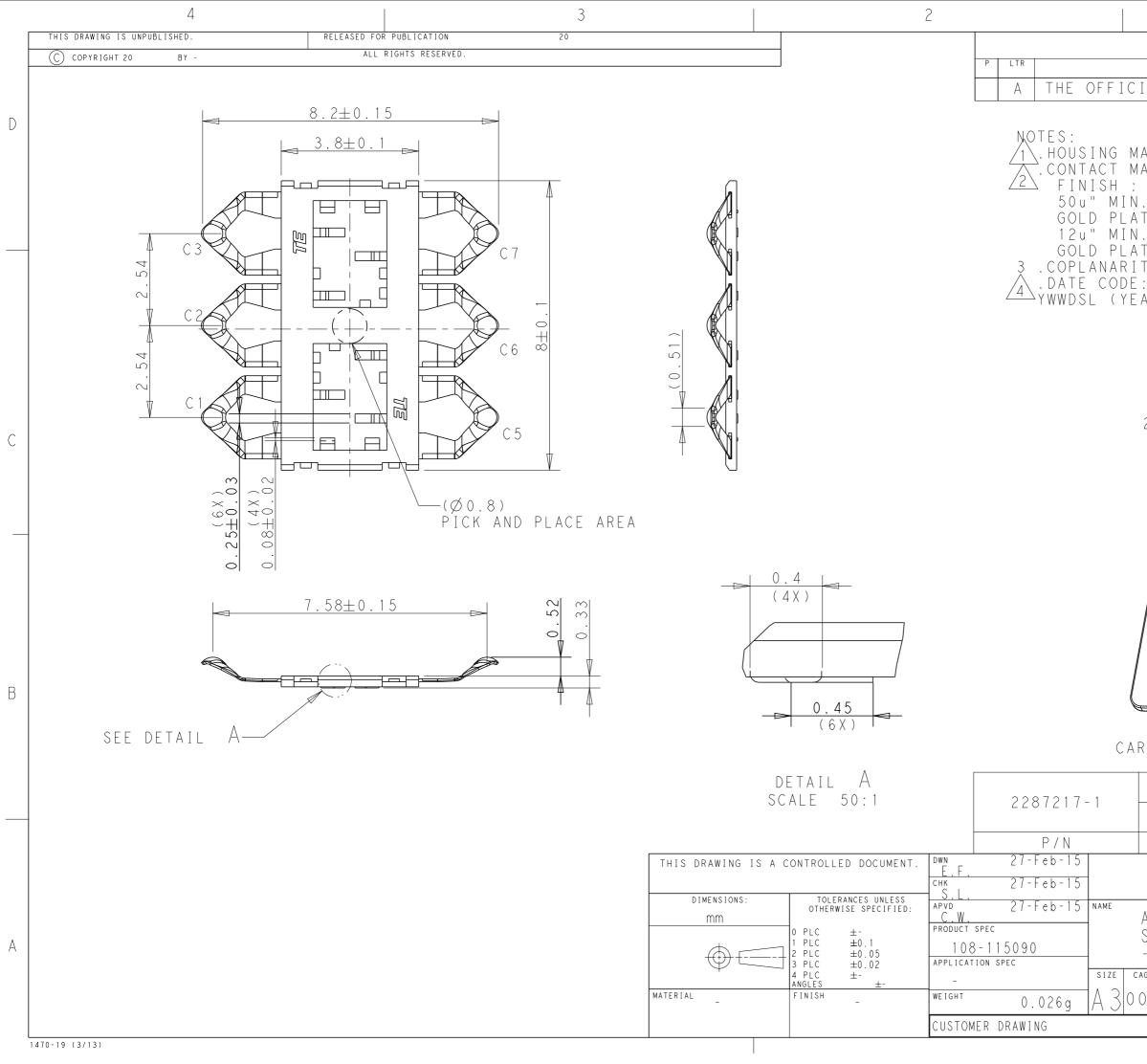
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



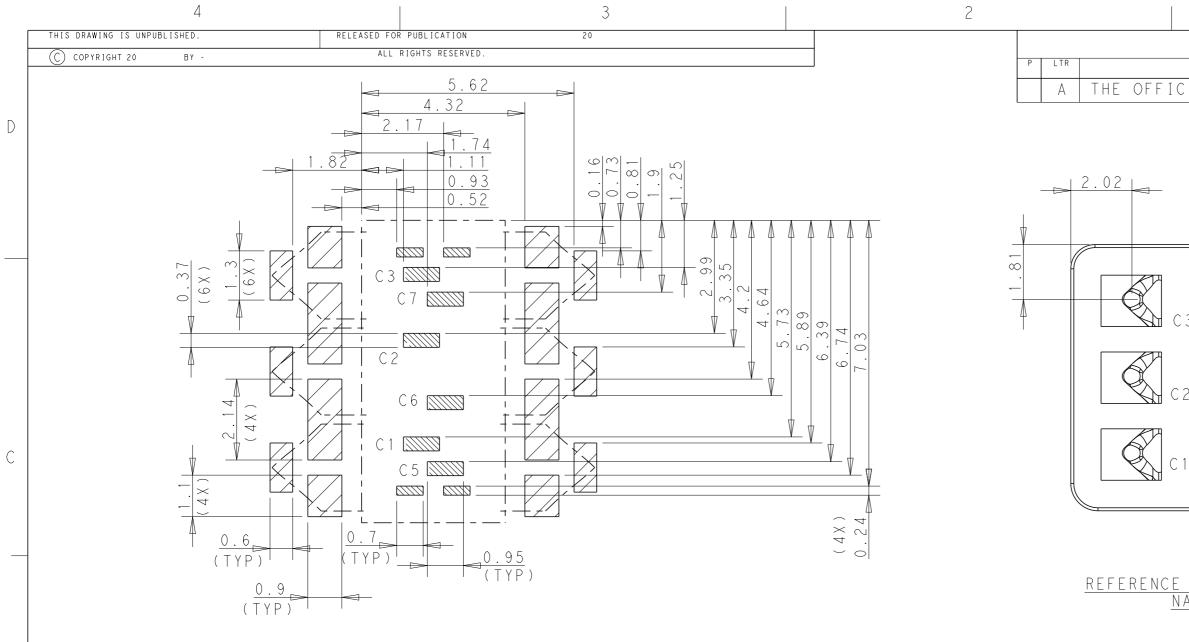
Contact us

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1	
REVISIONS	
DESCRIPTION DATE DWN APVD	
IAL VERSION RELEASED 27-Feb-15 E.F. C.W.	
ATERIAL: THERMO PLASTIC RESIN. ATERIAL: COPPER ALLOY. . NICKEL UNDERPLATING ALL OVER, TING 2" MIN. ON CONTACT AREA	D
. PD/Ni ON CONTACT AREA TING 1u" MIN. ON SOLDER AREA TY:0.08MAX.(BEFORE IR) : AR, WEEK , DAY, SHIFT, LINE)	
	С
RD INSERTION DIRECTION 2 CONTACT 1 HOUSING	В
ITEM COMPONENT MATERIAL/FINISH ITEM COMPONENT MATERIAL/FINISH ITE Connectivity ANTI-BUCKLING BLOCK SIM CONNECTOR SIDE ENTRY TYPE AGE CODE DRAWING NO RESTRICTED TO 0779 C=2287217 - SCALE 10:1 SHEET OF REV	A



REFERENCE P.C.BOARD LAYOUT (P.C.B. TOLERANCE:±0.05)

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SOLDER AREA

JULULIN ANLA

COPPER FOIL REMOVE & SOLDER MASK KEEP OUT (DEPTH:0.05~0.10MM)

CONNECTOR BOUNDARY

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4 PLC ±-	±	SIZE CAGE CODI			CTED TO
ERIAL _ FINISH _	0.0	26g A 3 00779	9 C - 2287217	SHEET 2 OF 2 RE	· W
	CUSTOMER DRAWING			2 2 2 ME	Ϋ́́A

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